



**THE DATASHEET OF
PS9513L3-E3-AX**



PS9513, PS9513L, PS9513L2, PS9513L3

1 Mbps, OPEN COLLECTOR OUTPUT, FOR GATE
 DRIVE INTERFACE INTELLIGENT POWER MODULE
 8 mm CREEPAGE 8-PIN DIP HIGH-SPEED
 PHOTOCOUPLER

Data Sheet
 R08DS0126EJ0200
 Rev.2.00
 Apr 13, 2015

Description

The PS9513, PS9513L1, PS9513L2 and PS9513L3 are optically coupled isolators containing a GaAlAs LED on the input side and a photo diode and a signal processing circuit on the output side on one chip.

The PS9513 is designed specifically for high common mode transient immunity (CMR) and low pulse width distortion with operating temperature. It is suitable for IPM drive.

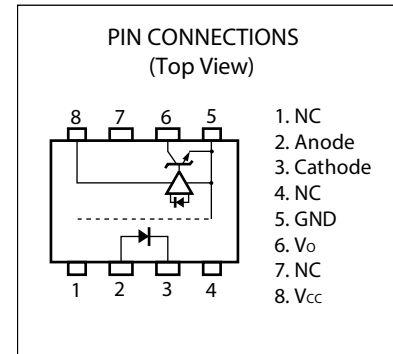
The PS9513L1 is lead bending type for long creepage distance.

The PS9513L2 is lead bending type for long creepage distance (Gull-wing) for surface mount.

The PS9513L3 is lead bending type (Gull-wing) for surface mounting.

Features

- Long creepage distance (8 mm MIN. : PS9513L1, PS9513L2)
- High common mode transient immunity ($CM_H, CM_L = \pm 15 \text{ kV}/\mu\text{s}$ MIN)
- High-speed response ($t_{PHL} = 500 \text{ ns}$ MAX., $t_{PLH} = 750 \text{ ns}$ MAX.)
- Maximum propagation delays ($t_{PLH} - t_{PHL} = 270 \text{ ns}$ TYP.)
- Pulse width distortion ($|t_{PHL} - t_{PLH}| = 270 \text{ ns}$ TYP.)
- Open collector output
- Ordering number of tape product : PS9513L2-E3 : 1 000 pcs/reel
 : PS9513L3-E3 : 1 000 pcs/reel
- Pb-Free product
- Safety standards
 - UL approved: No. E72422
 - CSA approved: No. CA 101391 (CA5A, CAN/CSA-C22.2 60065, 60950)
 - BSI approved: No. 8937, 8938
 - SEMKO approved: No. 1308848
 - NEMKO approved: No. P13217067
 - DEMKO approved: No. D-02380
 - FIMKO approved: No. FI 27913
 - DIN EN60747-5-5 (VDE0884-5):2011-11 approved: No. 40024069 (Option)

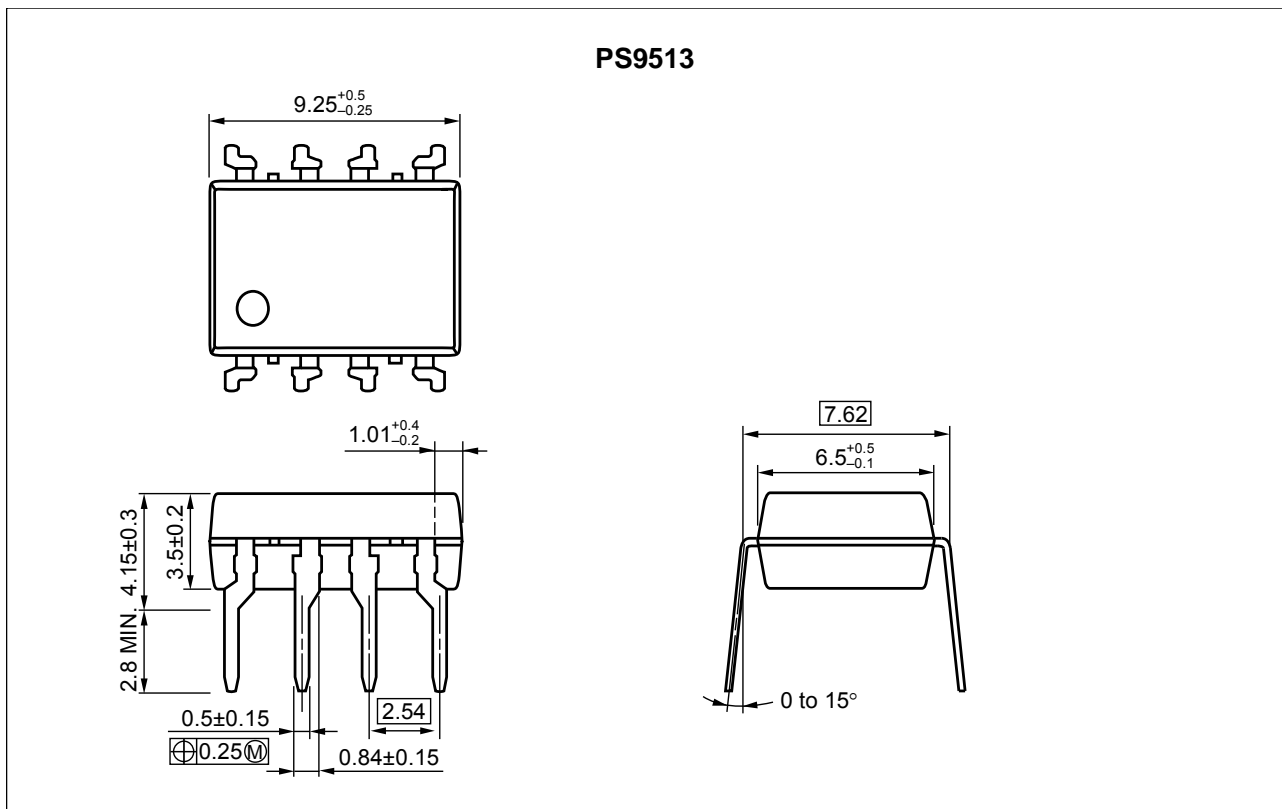


APPLICATIONS

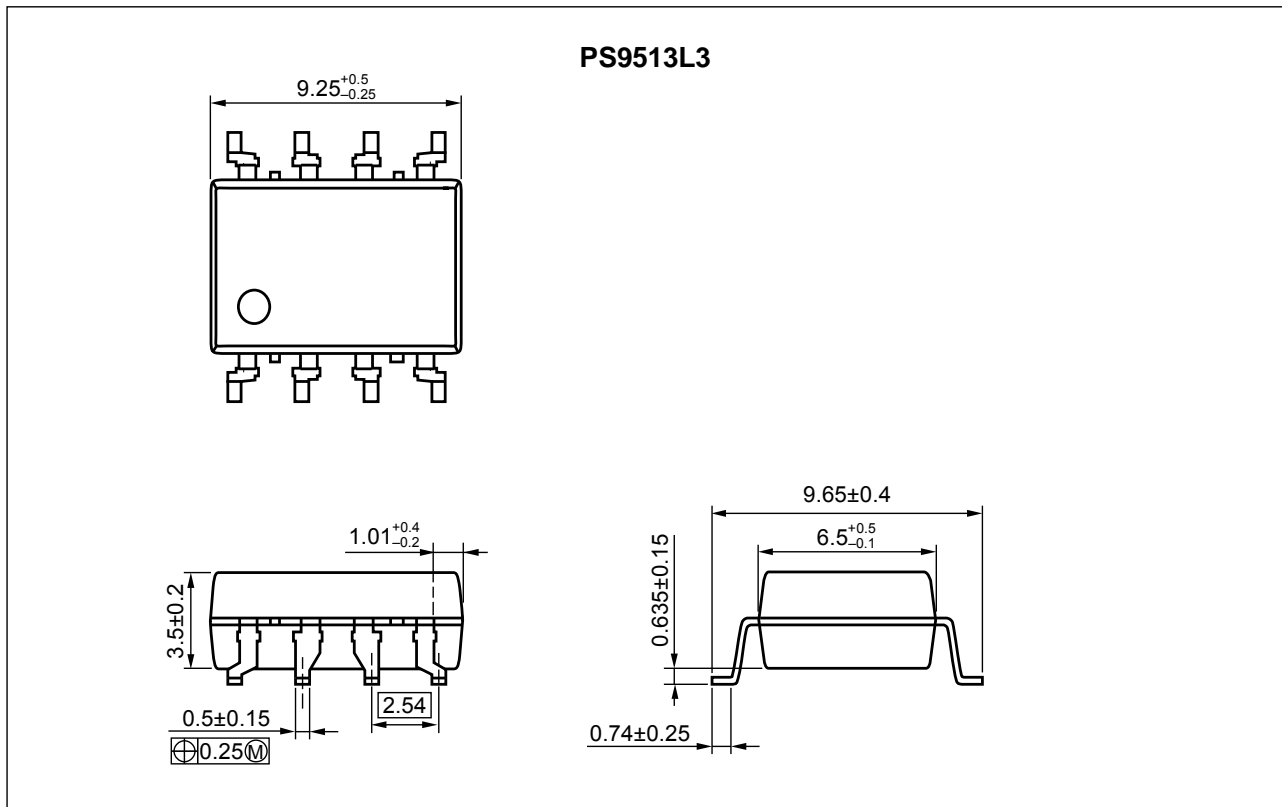
- IPM Driver
- General purpose inverter

PACKAGE DIMENSIONS (UNIT: mm)

- DIP Type

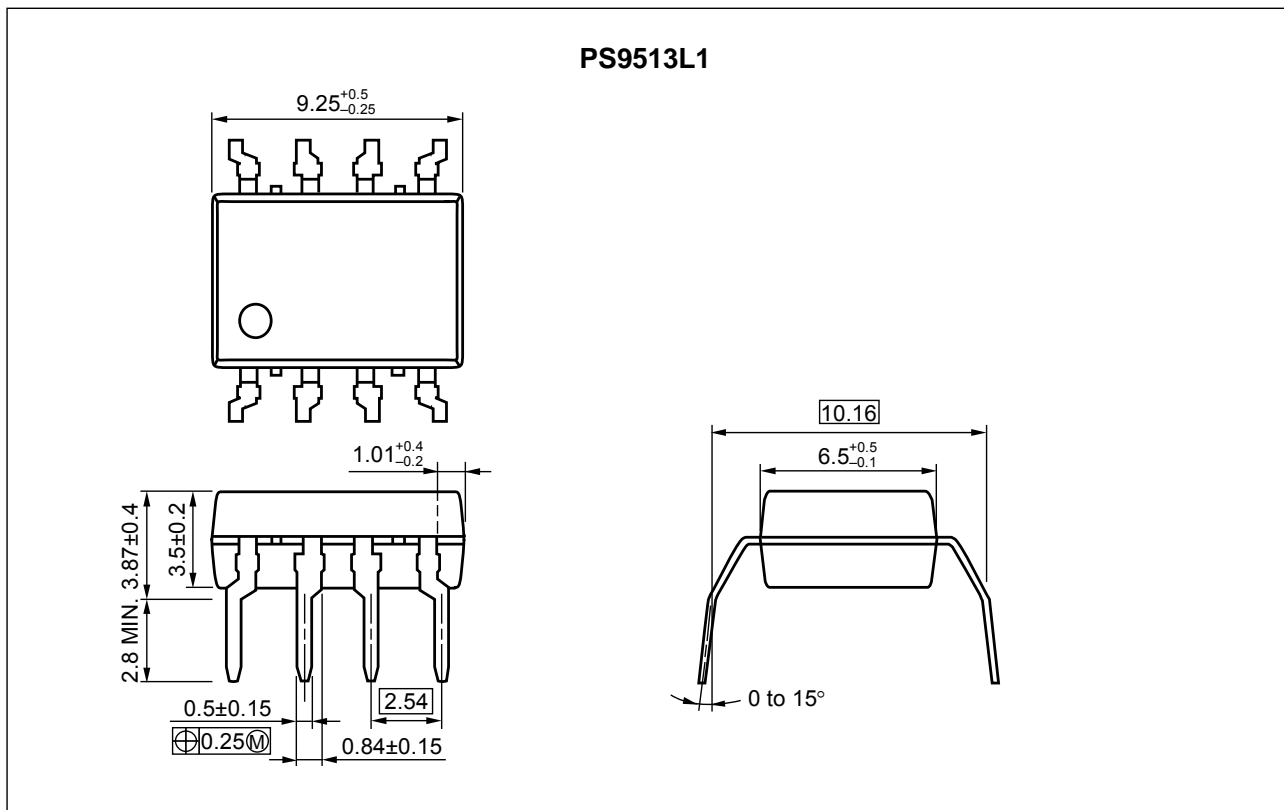


- Lead Bending Type (Gull-wing) For Surface Mount

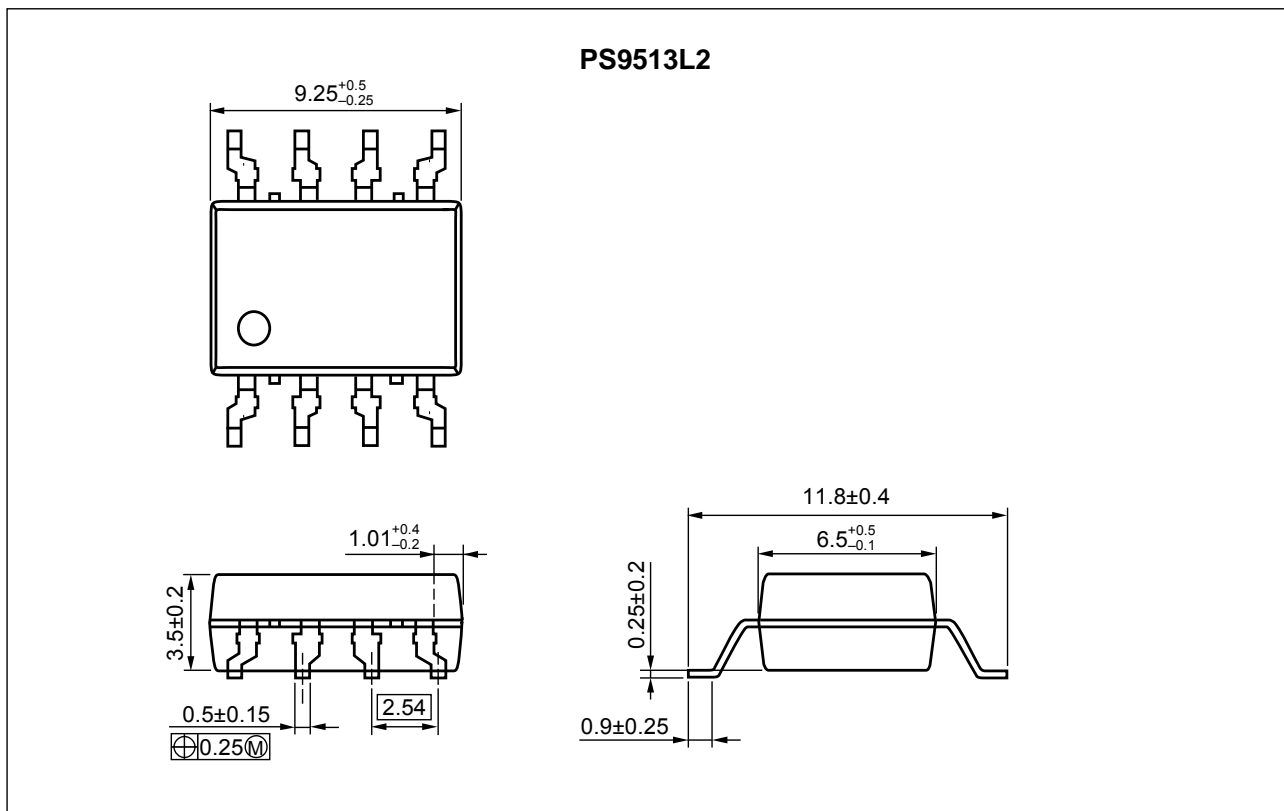


PS9513, PS9513L, PS9513L2, PS9513L3

- Lead Bending Type For Long Creepage Distance



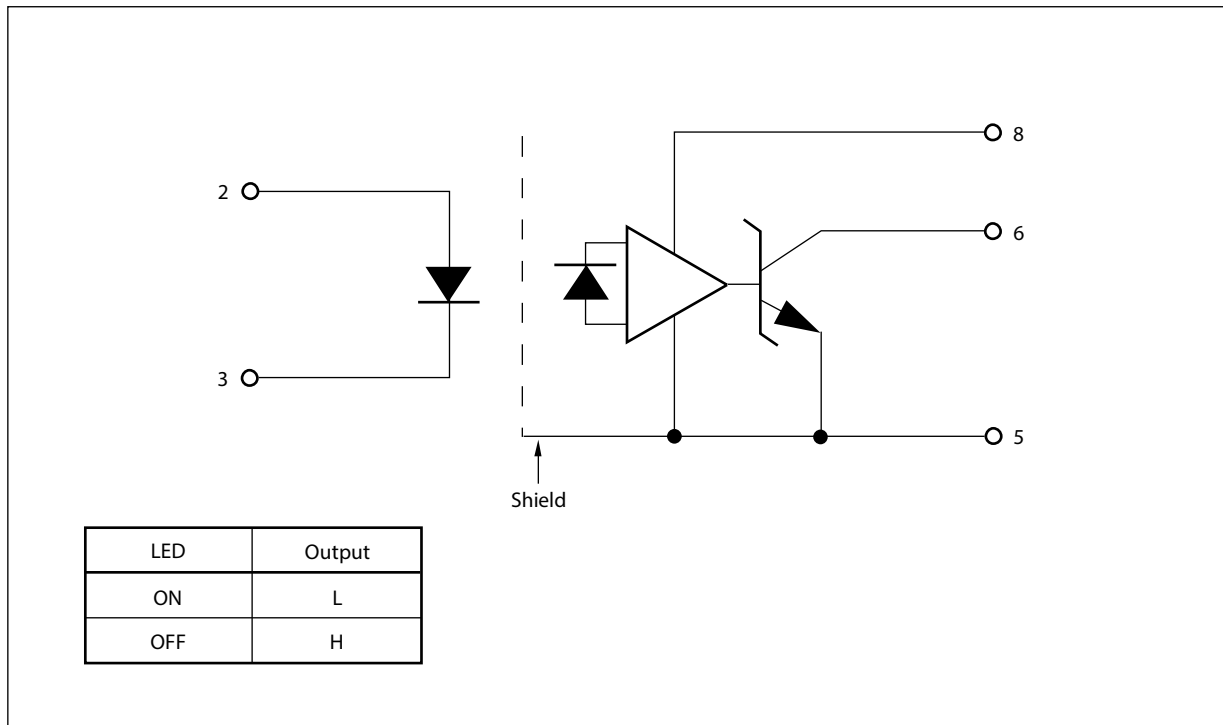
- Lead Bending Type For Long Creepage Distance (Gull-wing) For Surface Mount



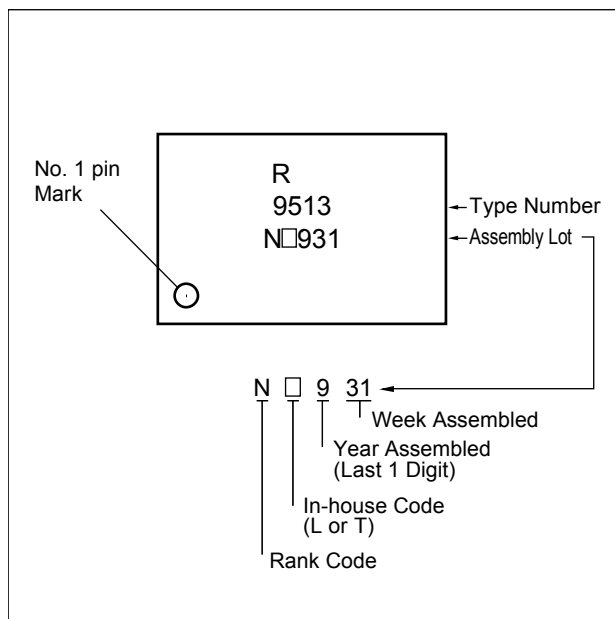
PHOTOCOUPLER CONSTRUCTION

| Parameter | PS9513, PS9513L3 | PS9513L1, PS9513L2 |
|--------------------------------|------------------|--------------------|
| Air Distance (MIN.) | 7 mm | 8 mm |
| Outer Creepage Distance (MIN.) | 7 mm | 8 mm |
| Isolation Distance (MIN.) | 0.4 mm | 0.4 mm |

FUNCTIONAL DIAGRAM



MARKING EXAMPLE



ORDERING INFORMATION

| Part Number | Order Number | Solder Plating Specification | Packing Style | Safety Standard Approval | Application Part Number*1 |
|---------------|------------------|------------------------------|------------------------------|---|---|
| PS9513 | PS9513-AX | Pb-Free (Ni/Pd/Au) | Magazine case 50 pcs | Standard products (UL, CSA, BSI, SEMKO, NEMKO, DEMKO, FIMKO approved) | PS9513 |
| PS9513L1 | PS9513L1-AX | | | | PS9513L1 |
| PS9513L2 | PS9513L2-AX | | | | PS9513L2 |
| PS9513L3 | PS9513L3-AX | | | | PS9513L3 |
| PS9513L2-E3 | PS9513L2-E3-AX | | Embossed Tape 1 000 pcs/reel | approved) | PS9513L2 |
| PS9513L3-E3 | PS9513L3-E3-AX | | | | PS9513L3 |
| PS9513-V | PS9513-V-AX | | Magazine case 50 pcs | | DIN EN60747-5-5 (VDE0884-5):2011- 11 Approved (Option) |
| PS9513L1-V | PS9513L1-V-AX | | | PS9513L1 | |
| PS9513L2-V | PS9513L2-V-AX | | | PS9513L2 | |
| PS9513L3-V | PS9513L3-V-AX | | | PS9513L3 | |
| PS9513L2-V-E3 | PS9513L2-V-E3-AX | | Embossed Tape 1 000 pcs/reel | | PS9513L2 |
| PS9513L3-V-E3 | PS9513L3-V-E3-AX | | | | PS9513L3 |

Notes*: 1. For the application of the Safety Standard, following part number should be used.

PS9513, PS9513L, PS9513L2, PS9513L3**ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)**

| Parameter | | Symbol | Ratings | Unit |
|-------------------------------|----------------------|------------------|-------------|---------|
| Diode | Forward Current *1 | I _F | 25 | mA |
| | Reverse Voltage | V _R | 5.0 | V |
| Detector | Supply Voltage | V _{CC} | -0.5 to +25 | V |
| | Output Voltage | V _O | -0.5 to +25 | V |
| | Output Current | I _O | 15 | mA |
| | Power Dissipation *2 | P _C | 100 | mW |
| Isolation Voltage *3 | | BV | 5 000 | Vr.m.s. |
| Operating Ambient Temperature | | T _A | -40 to +100 | °C |
| Storage Temperature | | T _{stg} | -55 to +125 | °C |

Notes*: 1. Reduced to 0.33 mA/°C at T_A = 70°C or more.

2. Reduced to 2.0 mW/°C at T_A = 70°C or more.

3. AC voltage for 1 minute at T_A = 25°C, RH = 60% between input and output.

Pins 1-4 shorted together, 5-8 shorted together.

RECOMMENDED OPERATING CONDITIONS

| Parameter | Symbol | MIN. | TYP. | MAX. | Unit |
|-----------------|-----------------|------|------|------|------|
| Forward Current | I _F | 10 | | 20 | mA |
| Output Voltage | V _O | 0 | | 20 | V |
| Supply Voltage | V _{CC} | 4.5 | 15 | 20 | V |
| Input Voltage | V _F | 0 | | 0.8 | V |

PS9513, PS9513L, PS9513L2, PS9513L3

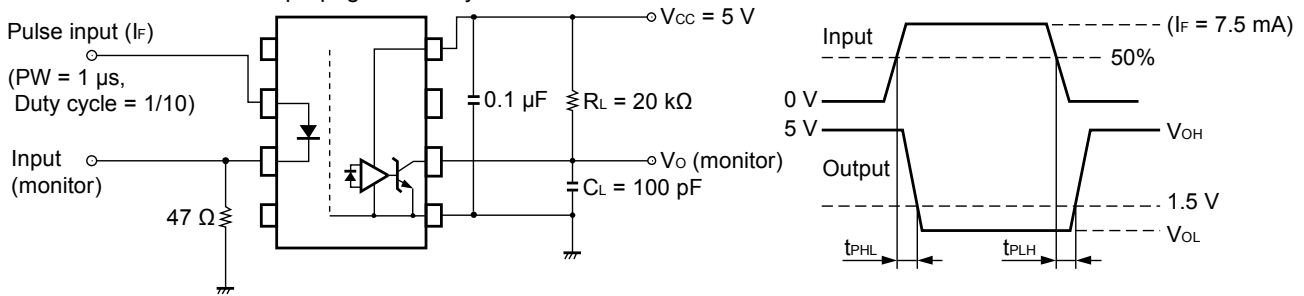
ELECTRICAL CHARACTERISTICS ($T_A = -40$ to $+100^\circ\text{C}$, $V_{CC} = 15$ V, unless otherwise specified)

| Parameter | | Symbol | Conditions | MIN. | TYP.*1 | MAX. | Unit |
|-----------|---|---------------------|--|-----------|--------|------|-------------------|
| Diode | Forward Voltage | V_F | $I_F = 10$ mA | 1.3 | 1.65 | 2.1 | V |
| | Reverse Current | I_R | $V_R = 3$ V | | | 200 | μA |
| | Terminal Capacitance | C_t | $V = 0$ V, $f = 1$ MHz, $T_A = 25^\circ\text{C}$ | | 30 | | pF |
| Detector | Low Level Output Voltage | V_{OL} | $I_F = 10$ mA, $I_{OL} = 2.4$ mA | | 0.13 | 0.6 | V |
| | High Level Output Current | I_{OH} | $V_{CC} = 20$ V, $V_F = 0.8$ V | | 1.0 | 50 | μA |
| | High Level Supply Current | I_{CCH} | $V_{CC} = 20$ V, $V_F = 0.8$ V, $V_O = \text{open}$ | | 0.6 | 1.3 | mA |
| | Low Level Supply Current | I_{CCL} | $V_{CC} = 20$ V, $I_F = 10$ mA, $V_O = \text{open}$ | | 0.6 | 1.3 | mA |
| Coupled | Threshold Input Current ($H \rightarrow L$) | I_{FHL} | $V_O = 0.8$ V, $I_O = 0.75$ mA | | 0.86 | 5.0 | mA |
| | Current Transfer Ratio (I_C/I_F) | CTR | $I_F = 10$ mA, $V_O = 0.6$ V | 44 | 110 | | % |
| | Isolation Resistance | R_{I-O} | $V_{I-O} = 1$ kV _{DC} , $R_H = 40$ to 60% , $T_A = 25^\circ\text{C}$ | 10^{11} | | | Ω |
| | Isolation Capacitance | C_{I-O} | $V = 0$ V, $f = 1$ MHz, $T_A = 25^\circ\text{C}$ | | 0.7 | | pF |
| | Propagation Delay Time ($H \rightarrow L$)*2 | t_{PHL} | $I_F = 10$ mA, $R_L = 20$ k Ω , $C_L = 100$ pF, $V_{THHL} = 1.5$ V, $V_{THLH} = 2.0$ V | | 250 | 500 | ns |
| | Propagation Delay Time ($L \rightarrow H$)*2 | t_{PLH} | | | 520 | 750 | |
| | Maximum Propagation Delays | $t_{PLH}-t_{PHL}$ | | -200 | 270 | 650 | |
| | Pulse Width Distortion (PWD)*2 | $ t_{PHL}-t_{PLH} $ | | | 270 | 650 | |
| | Common Mode Transient Immunity at High Level Output*3 | CM_H | $T_A = 25^\circ\text{C}$, $I_F = 0$ mA, $V_O > 3.0$ V, $V_{CM} = 1.5$ kV, $R_L = 20$ k Ω , $C_L = 100$ pF | 15 | | | kV/ μs |
| | Common Mode Transient Immunity at Low Level Output*3 | CM_L | $T_A = 25^\circ\text{C}$, $I_F = 10$ mA, $V_O < 1.0$ V, $V_{CM} = 1.5$ kV, $R_L = 20$ k Ω , $C_L = 100$ pF | 15 | | | kV/ μs |

PS9513, PS9513L, PS9513L2, PS9513L3

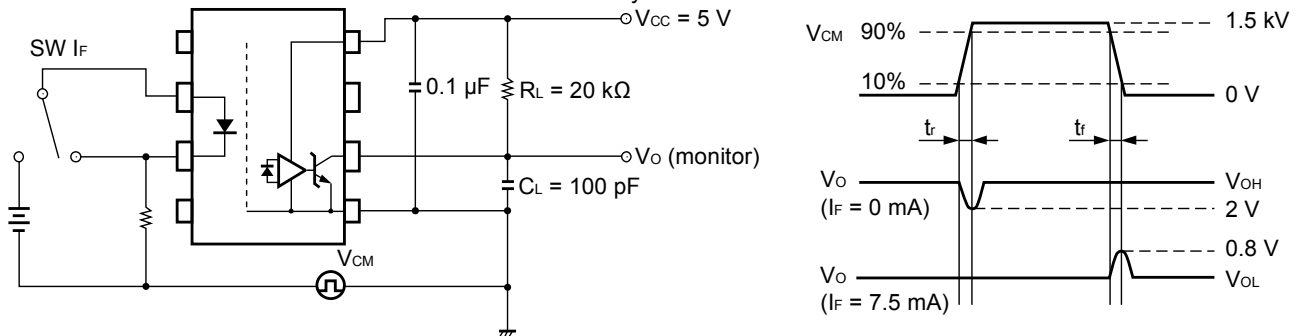
Notes*: 1. Typical values at $T_A = 25^\circ\text{C}$.

2. Test circuit for propagation delay time



Remark C_L includes probe and stray wiring capacitance.

3. Test circuit for common mode transient immunity



Remark C_L includes probe and stray wiring capacitance.

USAGE CAUTIONS

1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
2. By-pass capacitor of more than $0.1\ \mu\text{F}$ is used between V_{CC} and GND near device. Also, ensure that the distance between the leads of the photocopier and capacitor is no more than 10 mm.
3. Pins 1, 4 (which is an NC*1 pin) can either be connected directly to the GND pin on the LED side or left open. Also, Pin 7 (which is an NC*1 pin) can either be connected directly to the GND pin on the detector side or left open.

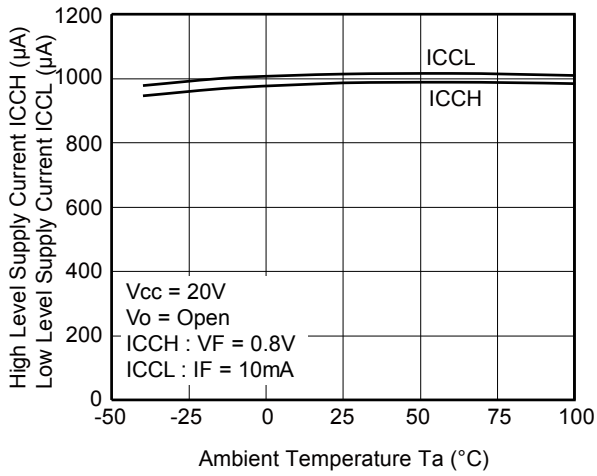
Unconnected pins should not be used as a bypass for signals or for any other similar purpose because this may degrade the internal noise environment of the device.

*1 NC: Non-Connection (No Connection)

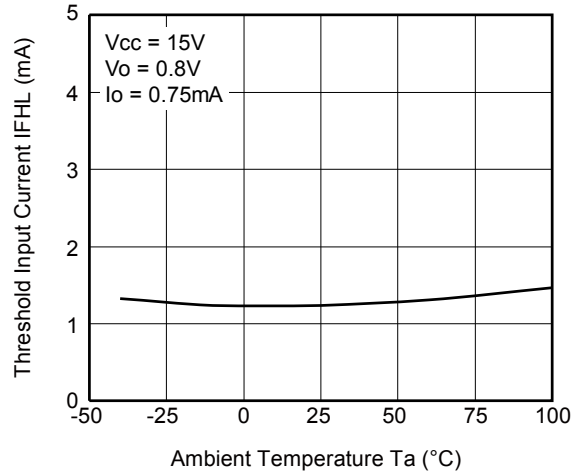
4. Avoid storage at a high temperature and high humidity.

TYPICAL CHARACTERISTICS (T_A = 25°C unless otherwise specified)

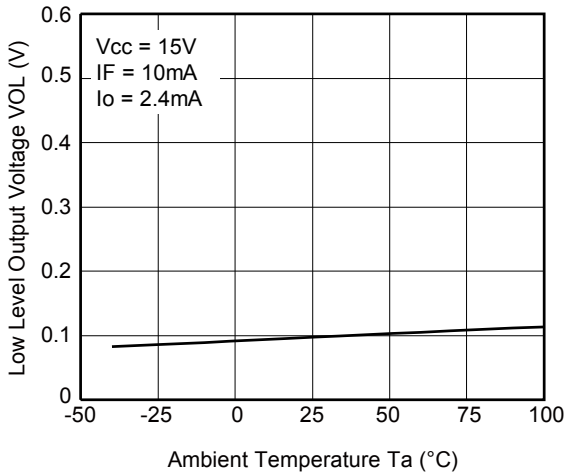
SUPPLY CURRENT vs. AMBIENT TEMPERATURE



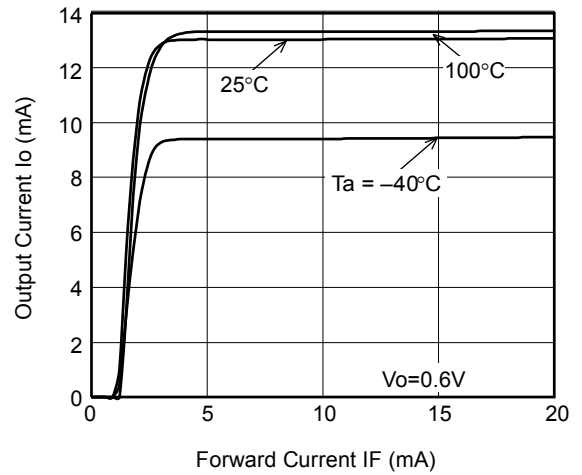
THRESHOLD INPUT CURRENT vs. AMBIENT TEMPERATURE



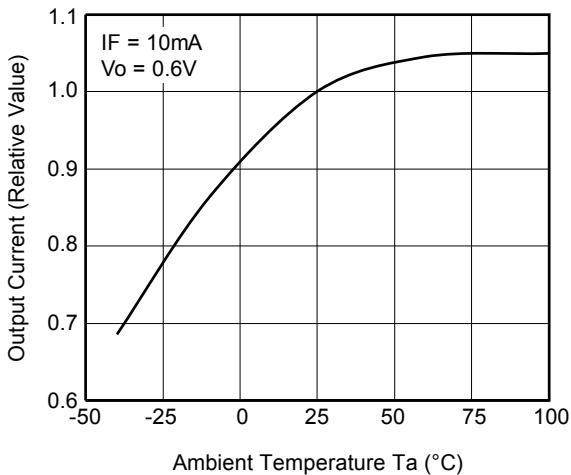
LOW LEVEL OUTPUT VOLTAGE vs. AMBIENT TEMPERATURE



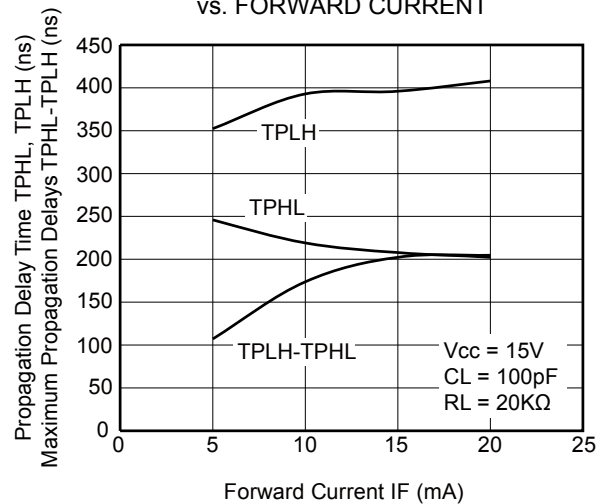
OUTPUT CURRENT vs. FORWARD CURRENT



OUTPUT CURRENT vs. AMBIENT TEMPERATURE

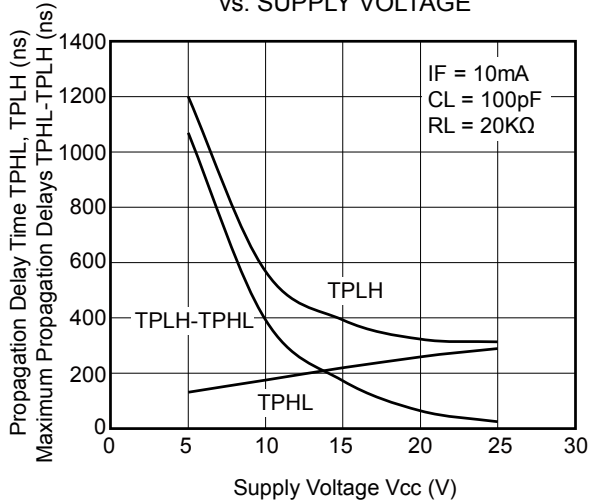


PROPAGATION DELAY TIME, MAXIMUM PROPAGATION DELAYS vs. FORWARD CURRENT

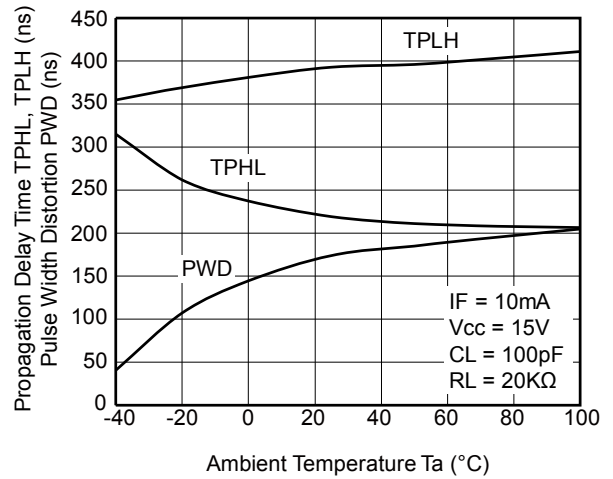


PS9513, PS9513L, PS9513L2, PS9513L3

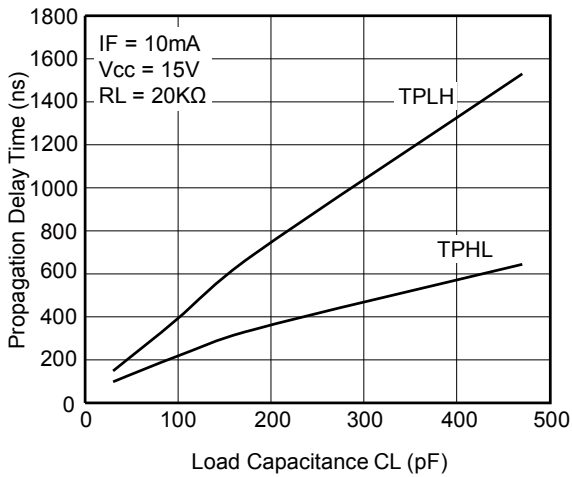
PROPAGATION DELAY TIME,
MAXIMUM PROPAGATION DELAYS
vs. SUPPLY VOLTAGE



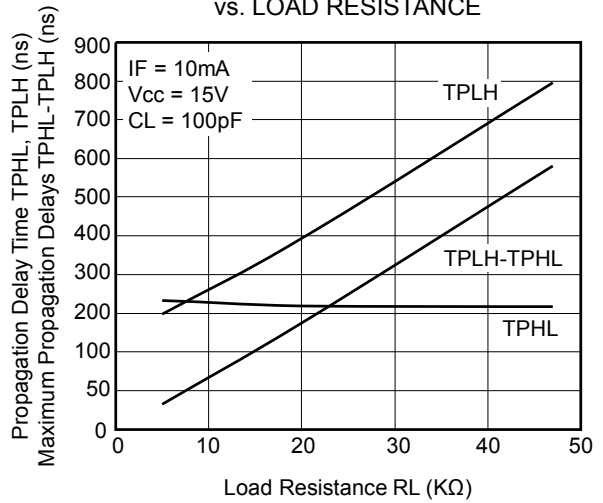
PROPAGATION DELAY TIME,
PULSE WIDTH DISTORTION
vs. AMBIENT TEMPERATURE



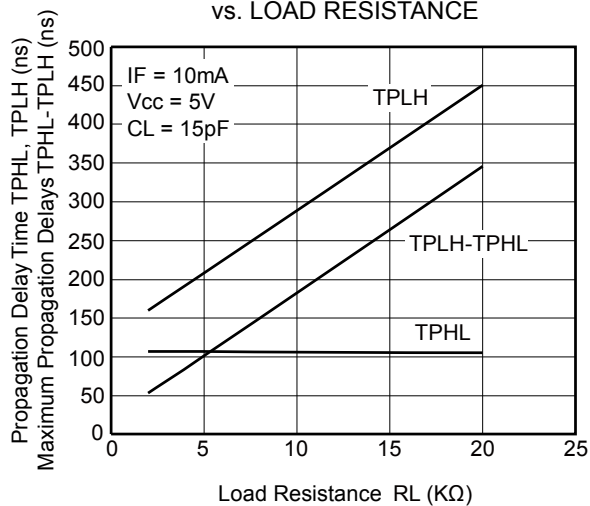
PROPAGATION DELAY TIME
vs. LOAD CAPACITANCE



PROPAGATION DELAY TIME,
MAXIMUM PROPAGATION DELAYS
vs. LOAD RESISTANCE

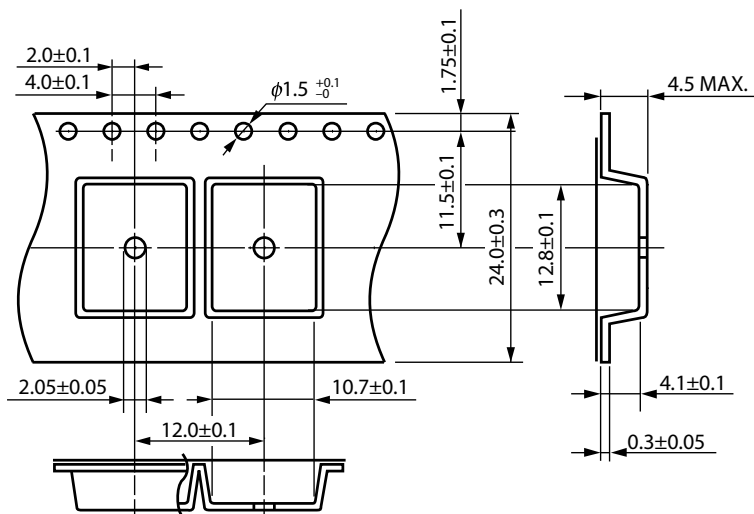


PROPAGATION DELAY TIME,
MAXIMUM PROPAGATION DELAYS
vs. LOAD RESISTANCE

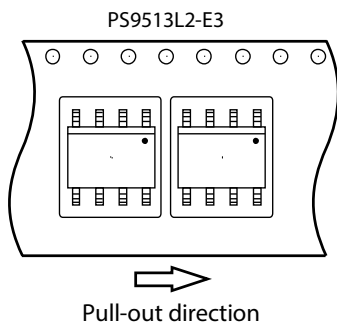


TAPING SPECIFICATIONS (UNIT: mm)

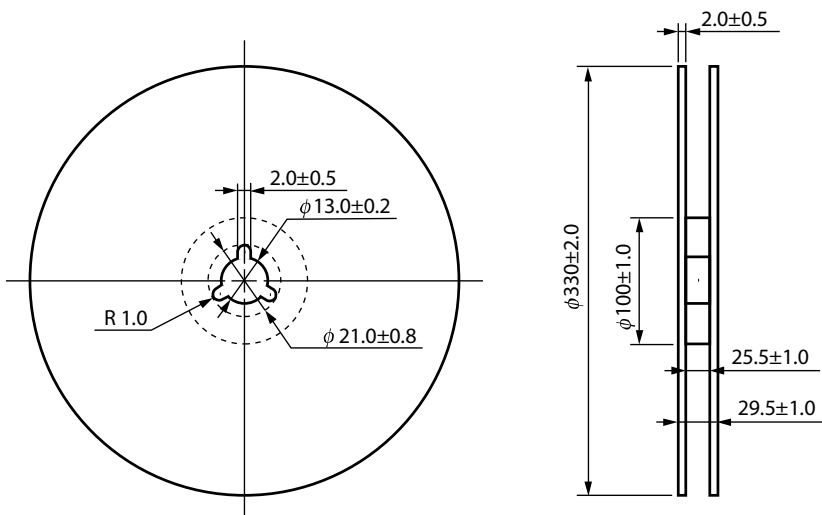
Outline and Dimensions (Tape)



Tape Direction

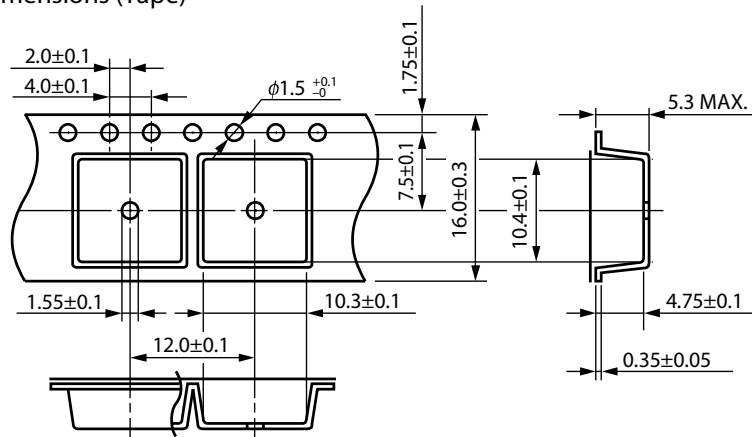


Outline and Dimensions (Reel)

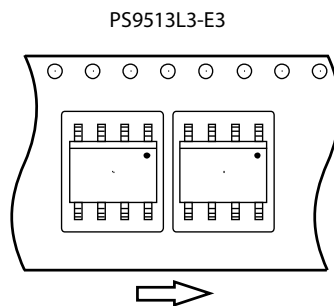


Packing: 1 000 pcs/reel

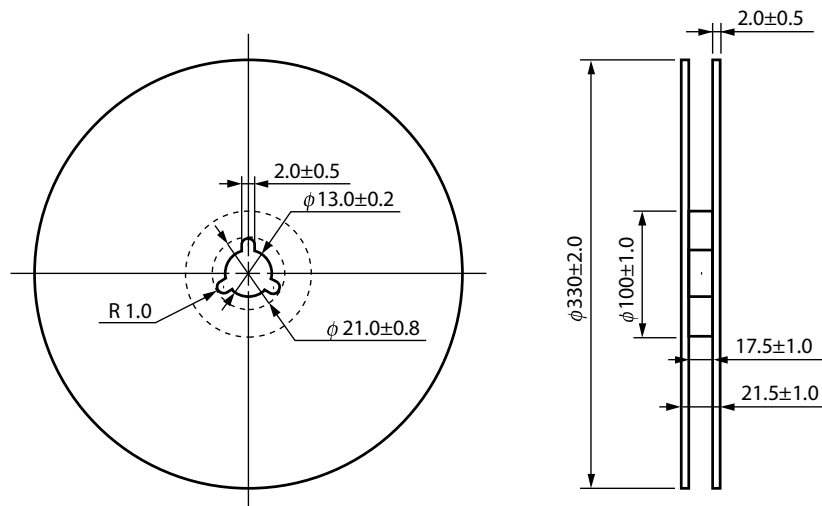
Outline and Dimensions (Tape)



Tape Direction

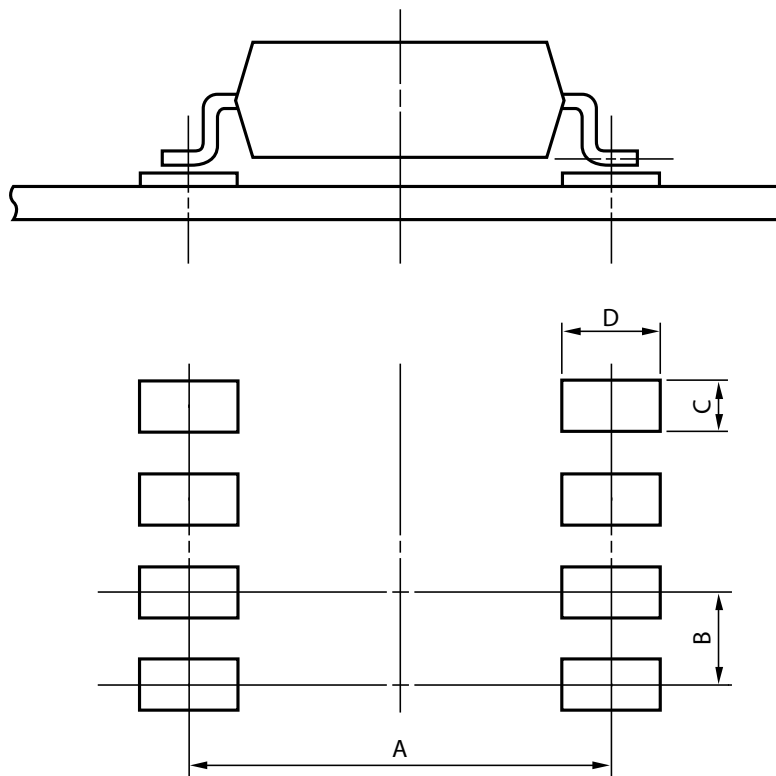


Outline and Dimensions (Reel)



Packing: 1 000 pcs/reel

RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



| Part Number | Lead Bending | A | B | C | D |
|-------------|---|------|------|-----|-----|
| PS9513L2 | lead bending type (Gull-wing) for long creepage distance (surface mount) | 10.2 | 2.54 | 1.7 | 2.2 |
| PS9513L3 | lead bending type (Gull-wing) for surface mount | 8.2 | 2.54 | 1.7 | 2.2 |

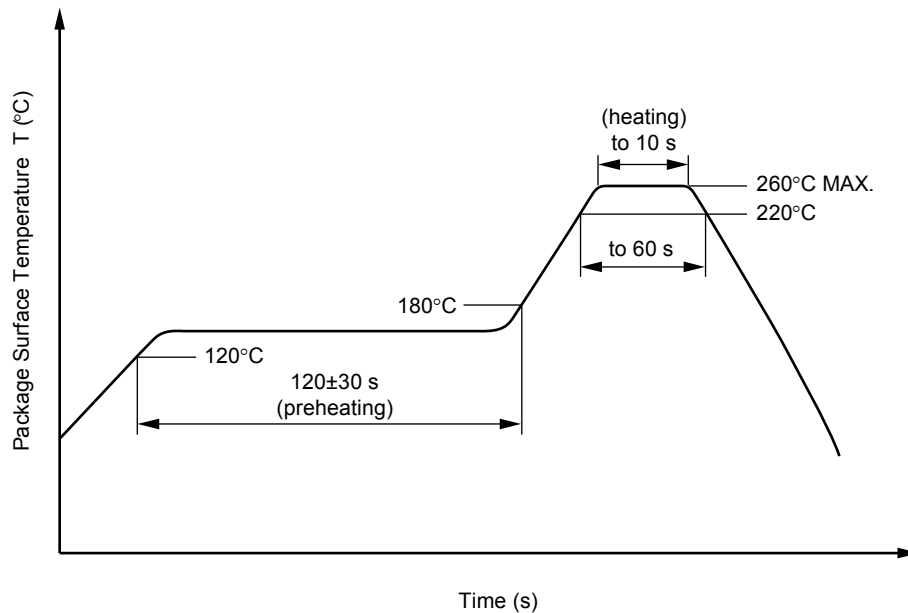
NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

- Peak reflow temperature 260°C or below (package surface temperature)
- Time of peak reflow temperature 10 seconds or less
- Time of temperature higher than 220°C 60 seconds or less
- Time to preheat temperature from 120 to 180°C 120±30 s
- Number of reflows Three
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

- Peak Temperature (lead part temperature) 350°C or below
- Time (each pins) 3 seconds or less
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead

(b) Please be sure that the temperature of the package would not be heated over 100°C

(4) Cautions

- Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between V_{CC}-GND at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

| Parameter | Symbol | Speck | Unit |
|--|------------|-------------|--------------------|
| Climatic test class (IEC 60068-1/DIN EN 60068-1) | | 40/100/21 | |
| Dielectric strength maximum operating isolation voltage | U_{IORM} | 1 130 | V_{peak} |
| Test voltage (partial discharge test, procedure a for type test and random test) $U_{pr} = 1.6 \times U_{IORM}, P_d < 5 \text{ pC}$ | U_{pr} | 1 808 | V_{peak} |
| Test voltage (partial discharge test, procedure b for all devices) $U_{pr} = 1.875 \times U_{IORM}, P_d < 5 \text{ pC}$ | U_{pr} | 2 119 | V_{peak} |
| Highest permissible overvoltage | U_{TR} | 8 000 | V_{peak} |
| Degree of pollution (DIN EN 60664-1 VDE 0110 Part 1) | | 2 | |
| Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303 Part 11)) | CTI | 175 | |
| Material group (DIN EN 60664-1 VDE 0110 Part 1) | | III a | |
| Storage temperature range | T_{stg} | -55 to +125 | $^{\circ}\text{C}$ |
| Operating temperature range | T_A | -40 to +100 | $^{\circ}\text{C}$ |
| Isolation resistance, minimum value $V_{IO} = 500 \text{ V dc at } T_A = 25^{\circ}\text{C}$ | Ris MIN. | 10^{12} | Ω |
| $V_{IO} = 500 \text{ V dc at } T_A \text{ MAX. at least } 100^{\circ}\text{C}$ | Ris MIN. | 10^{11} | Ω |
| Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve) | | | |
| Package temperature | T_{si} | 175 | $^{\circ}\text{C}$ |
| Current (input current I_F , $P_{si} = 0$) | I_{si} | 400 | mA |
| Power (output or total power dissipation) | P_{si} | 700 | mW |
| Isolation resistance $V_{IO} = 500 \text{ V dc at } T_A = T_{si}$ | Ris MIN. | 10^9 | Ω |

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
 1. Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

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